

October 1989 Revised August 1999

## 74FR16540

## 16-Bit Buffer/Line Driver with 3-STATE Outputs

#### **General Description**

The 74FR16540 contains sixteen inverting buffers with 3-STATE outputs designed to be employed as a memory and address driver, clock driver, or bus-oriented transmitter/ receiver. The device is byte controlled. Each byte has separate 3-STATE control inputs which can be shorted together for full 16-bit operation.

#### **Features**

- Inverting buffers
- 3-STATE outputs drive bus lines
- Output sink capability of 64 mA, source capability of
- Separate 3-STATE control pins for each byte
- Guaranteed 4000V minimum ESD protection
- Guaranteed multiple output switching, 250 pF delays and pin-to-pin skew
- 16-bit version of the 74F540, 74F240, or 74FR240

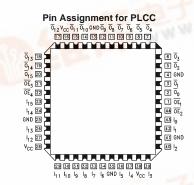
#### **Ordering Code:**

Order Number	Package Number	Package Description
74FR16540QC	V44A	44-Lead Plastic Lead Chip Carrier (PLCC), JEDEC MO-047, 0.650 Square
74FR16540SSC	MS48A	48-Lead Small Shrink Outline Package (SSOP), JEDEC MO-118, 0.300 Wide

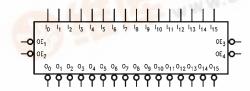
Devices also available in Tape and Reel. Specify by appending the suffix letter "X" to the ordering code.

## **Connection Diagrams**





#### **Logic Symbol**





## **Pin Descriptions**

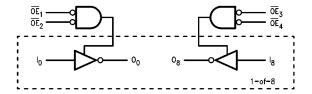
Pin Names	Description				
<del>OE</del> n	Output Enable Inputs				
I <sub>0</sub> -I <sub>15</sub>	Inputs				
$\overline{O}_0 - \overline{O}_{15}$	3-STATE Outputs				

## **Truth Table**

	Inputs						Outputs		
Byte1	[0:7] OE <sub>2</sub>	Byte2 OE <sub>3</sub>	[8:15] OE <sub>4</sub>	I <sub>0</sub> –I <sub>7</sub> I <sub>8</sub> –I <sub>15</sub>		$\overline{O}_0-\overline{O}_7$	O <sub>8</sub> -O <sub>15</sub>		
L	L	L	L	Н	Н	L	L		
Н	Χ	L	L	Х	L	Z	Н		
Х	Н	L	L	Х	Н	Z	L		
L	L	Н	Χ	L	Χ	Н	Z		
L	L	Х	Н	Н	Χ	L	Z		
Н	Н	Н	Н	Х	Χ	Z	Z		
L	L	L	L	L	L	Н	Н		

- H = HIGH Voltage Level L = LOW Voltage Level X = Immaterial Z = High Impedance

## Logic Diagram



## **Absolute Maximum Ratings**(Note 1)

# **Recommended Operating Conditions**

Storage Temperature —65°C to +150°C

Ambient Temperature under Riss —55°C to +125°C

 $\begin{array}{ll} \mbox{Ambient Temperature under Bias} & -55^{\circ}\mbox{C to } +125^{\circ}\mbox{C} \\ \mbox{Junction Temperature under Bias} & -55^{\circ}\mbox{C to } +150^{\circ}\mbox{C} \\ \end{array}$ 

 $V_{CC}$  Pin Potential to Ground Pin -0.5V to +7.0V Input Voltage (Note 2) -0.5V to +7.0V Input Current (Note 2) -30 mA to +5.0 mA

Voltage Applied to Output

in HIGH State (with  $V_{CC} = 0V$ )

 $\begin{array}{ll} \text{Standard Output} & -0.5 \text{V to V}_{\text{CC}} \\ \text{3-STATE Output} & -0.5 \text{V to} + 5.5 \text{V} \end{array}$ 

Current Applied to Output

in LOW State (Max) Twice the Rated I<sub>OL</sub> (mA) ESD Last Passing Voltage (Min) 4000V

Free Air Ambient Temperature  $0^{\circ}\text{C} \text{ to } +70^{\circ}\text{C}$ Supply Voltage +4.5V to +5.5V

-0.5V to  $V_{\rm CC}$  Note 1: Absolute maximum ratings are values beyond which the device may be damaged or have its useful life impaired. Functional operation

under these conditions is not implied.

Note 2: Either voltage limit or current limit is sufficient to protect inputs.

#### **DC Electrical Characteristics**

Symbol	Parameter	Min	Тур	Max	Units	V <sub>CC</sub>	Conditions
V <sub>IH</sub>	Input HIGH Voltage	2.0			V		Recognized as a HIGH Signal
V <sub>IL</sub>	Input LOW Voltage			0.8	V		Recognized as a LOW Signal
V <sub>CD</sub>	Input Clamp Diode Voltage			-1.2	V	Min	I <sub>IN</sub> = -18 mA
V <sub>OH</sub>	Output HIGH Voltage	2.4			V	Min	$I_{OH} = -3 \text{ mA}$
		2.0			V	IVIIII	$I_{OH} = -15 \text{ mA}$
V <sub>OL</sub>	Output LOW Voltage			0.55	V	Min	I <sub>OL</sub> = 64 mA
Ін	Input HIGH Current			5.0	μΑ	Max	V <sub>IN</sub> = 2.7V
BVI	Input HIGH Current			7.0	_	Maria	V <sub>IN</sub> = 7.0V
	Breakdown Test			7.0	μΑ	Max	$(\overline{OE}_n)$
IL	Input LOW Current			-120	μΑ	Max	V <sub>IN</sub> = 0.5V
los	Output Short-Circuit Current	-100		-225	mA	Max	V <sub>OUT</sub> = 0V
l <sub>ozh</sub>	Output Leakage Current		0	20	μΑ	Max	V <sub>OUT</sub> = 2.7V
l <sub>OZL</sub>	Output Leakage Current		0	-20	μΑ	Max	V <sub>OUT</sub> = 0.5V
CEX	Output HIGH Leakage Current			50	μΑ	Max	$V_{OUT} = V_{CC}$
V <sub>ID</sub>	Input Leakage Test	4.75			V	0.0	$I_{ID} = 1.9 \mu A$
							All Other Pins Grounded
OD	Output Circuit			3.75	μА	0.0	V <sub>IOD</sub> = 150 mV
	Leakage Current			3.73	μΛ	0.0	All Other Pins Grounded
l <sub>ZZ</sub>	Bus Drainage Test			100	μΑ	0.0	V <sub>OUT</sub> = 5.25V
Іссн	Power Supply Current		14	20	mA	Max	V <sub>O</sub> = HIGH
I <sub>CCL</sub>	Power Supply Current		75	92	mA	Max	$V_O = LOW$
I <sub>CCZ</sub>	Power Supply Current		38	50	mA	Max	V <sub>O</sub> = HIGH Z
C <sub>IN</sub>	Input Capacitance		8		pF	5.0	

#### **AC Electrical Characteristics**

Symbol	Parameter	$\begin{aligned} T_{A} &= +25^{\circ}C \\ V_{CC} &= +5.0V \\ C_{L} &= 50 \text{ pF} \end{aligned}$			$T_A = 0$ °C to +70°C $V_{CC} = +5.0V$ $C_L = 50$ pF		Units
		Min	Тур	Max	Min	Max	
t <sub>PLH</sub>	Propagation Delay	1.0	2.8	4.3	1.0	4.3	
t <sub>PHL</sub>	In to On	1.0	2.0	4.3	1.0	4.3	ns
t <sub>PZH</sub>	Output Enable Time	3.4	5.6	11.6	3.4	11.6	20
$t_{PZL}$		3.4	7.8	11.6	3.4	11.6	ns
t <sub>PHZ</sub>	Output Disable Time	1.8	4.0	6.6	1.8	6.6	ns
$t_{PLZ}$		1.8	4.4	6.6	1.8	6.6	115

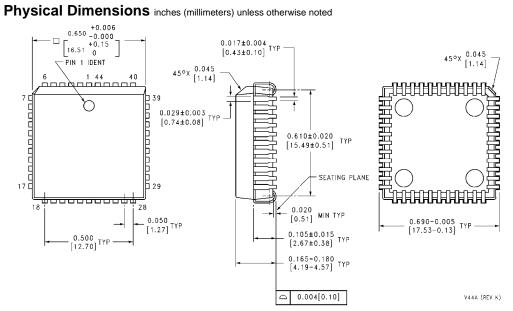
### **Extended AC Characteristics**

			$T_A = 0$ °C to +70°C $V_{CC} = +5.0V$		$T_A = 0$ °C to +70°C $V_{CC} = +5.0V$	
Symbol	Parameter	C <sub>L</sub> = 50 pF 16 Outputs Switching		C <sub>L</sub> = 250 pF		Units
Cymbol	i didilete.					Oille
		(Note 4)		(Note 5)		
		Min	Max	Min	Max	
t <sub>PLH</sub>	Propagation Delay	1.0	6.0	3.2	8.2	ns
t <sub>PHL</sub>	In to $\overline{O}$ n	1.0	6.0	3.2	8.2	115
t <sub>PZH</sub>	Output Enable Time	3.4	14.5			ns
t <sub>PZL</sub>		3.4	14.5			113
t <sub>PHZ</sub>	Output Disable Time	1.8	6.6			ns
t <sub>PLZ</sub>		1.8	6.6			113
toshl	Pin-to-Pin Skew		1.4			ns
(Note 3)	for HL Transitions		1.4			113
toslh	Pin-to-Pin Skew		1.6			ns
(Note 3)	for LH Transitions					110
t <sub>OST</sub>	Pin-to-Pin Skew		3.0			ns
(Note 3)	for HL/LH Transitions		5.0			113

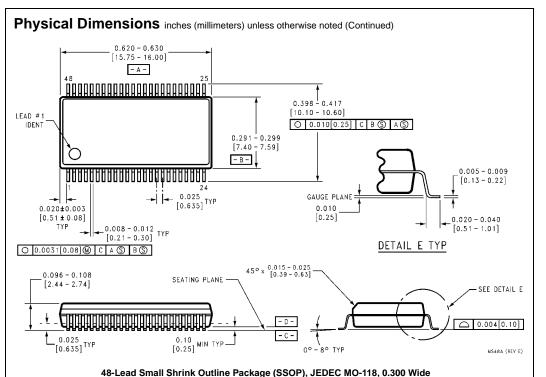
Note 3: Skew is defined as the absolute value of the difference between the actual propagation delays for any two outputs of the same device. The specification applies to any outputs switching HIGH-to-LOW (t<sub>OSHL</sub>), LOW-to-HIGH, (t<sub>OSLH</sub>), or HIGH-to-LOW and/or LOW-to-HIGH, (t<sub>OST</sub>). Specifications guaranteed with all outputs switching in phase. This specification is guaranteed but not tested.

Note 4: This specification is guaranteed but not tested. The limits apply to propagation delays for all paths described switching in phase, i.e., all LOW-to-HIGH, HIGH-to-LOW, 3-STATE-to-HIGH, etc.

Note 5: These specifications guaranteed but not tested. The limits represent propagation delays with 250 pF load capacitors in place of the 50 pF load capacitors in the standard AC load. This specification pertains to single output switching only.



44-Lead Plastic Lead Chip Carrier (PLCC), JEDEC MO-047, 0.650 Square Package Number V44A



Package Number MS48A

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